

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Michael Bauer et al.	Examiner:	Julia Slutsker
Serial No.:	10/565,259	Group Art Unit:	2891
Filed:	January 19, 2006	Docket No.:	1431.45.101/FIN606PCT/US
Title:	SUPPORT WITH SOLDER BALL ELEMENTS AND A METHOD FOR POPULATING SUBSTRATES WITH SOLDER BALLS		

AMENDMENT AND RESPONSE

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

This Amendment and Response is in reply to the Non-Final Office Action mailed August 12, 2009. Please amend the above-identified patent application as follows: